

TOSHIBA Zener Diode Silicon Epitaxial Planar Type

# **MUZ12V**

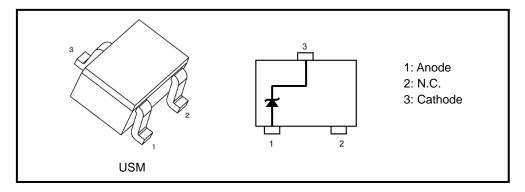
#### **Applications**

Voltage surge protection

#### **Features**

- ·Small package
- •The typical voltage of Vz is accorded to E24 series

#### **Packaging and Internal Circuit**



#### Absolute Maximum Ratings 1 (Note) (Unless otherwise specified, $T_a = 25^{\circ}C$ )

Characteristics	Symbol	Rating	Unit
Power dissipation	P <sub>D</sub> *1	150	mW
	PD <sup>*2</sup>	600	mW
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 to 150	°C

#### Absolute Maximum Ratings 2 (Note) (Unless otherwise specified, Ta = 25°C)

Type No.	Electrostatic discharge voltage *3		Peak pulse Peak pulse		Type No.	Electrostatic discharge voltage *3		Peak pulse	Peak pulse
	Contact	Air	power *4	current*4		Contact	Air	power *4	current*4
	VESI	o(kV)	P <sub>PK</sub> (W)	I <sub>PP</sub> (A)		VESI	V <sub>ESD</sub> (kV)		Ipp(A)
MUZ5V6	± 30		155	12	MUZ12V	± 30		200	7
MUZ6V2	± 30		175	11	MUZ16V	± 30		200	5.5
MUZ6V8	MUZ6V8 ± 30		180	10	MUZ24V	±	30	200	4.5

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

- \*1: Mounted on a glass epoxy circuit board of 25.4 mm  $\times$  25.4 mm  $\times$  1.6 mm, Cu pad: 0.5 mm<sup>2</sup> x 3
- \*2: Mounted on a glass epoxy circuit board of 25.4 mm × 25.4 mm × 1.6 mm, Cu pad: 645 mm<sup>2</sup>
- \*3: according to IEC61000-4-2
- \*4: according to IEC61000-4-5, tp = 8 / 20 μs

Start of commercial production 2020-07



## MUZ series Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

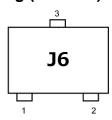
Type No.	Zener Voltage		Dynamic Impedance		Dynamic resistance	Clamp voltage	Total capacitance	Reverse Current			
	Vz (V) *1		Test Current			$R_{DYN}(\Omega)^{*2}$	Vc (V) *2*3	C <sub>t</sub> (pF) *4	I <sub>R</sub> (µA)	Test Voltage	
	Min	Тур.	Max	I <sub>Z</sub> (mA)	Max	I <sub>Z</sub> (mA)	Тур.	Тур.	Тур.	Max	V <sub>R</sub> (V)
MUZ5V6	5.3	5.6	6.0	5	30	5	0.16	9	125	1	3.5
MUZ6V2	5.8	6.2	6.6	5	30	5	0.21	10	105	2.5	5.0
MUZ6V8	6.4	6.8	7.2	5	30	5	0.27	13	88	1.5	5.5
MUZ12V	11.4	12	12.6	5	30	5	0.7	26	44	0.1	10
MUZ16V	15.3	16	17.1	5	35	5	0.5	27	35	0.1	14
MUZ24V	22.8	24	25.6	5	70	5	0.6	36.5	26	0.1	19

<sup>\*1:</sup> Test time: t = 30 ms

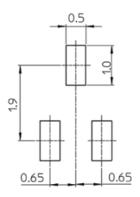
#### **Marking List**

Type No.	Marking	Type No.	Marking
MUZ5V6	J1	MUZ12V	J6
MUZ6V2	J2	MUZ16V	J7
MUZ6V8	J3	MUZ24V	JB

## Marking (MSZ12V)



## Land Pattern Dimensions (for reference only) (Unit: mm)



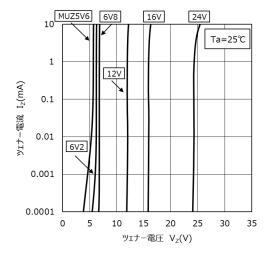
<sup>\*2:</sup> TLP parameters:  $Z_0 = 50 \Omega$ ,  $t_P = 100 \text{ ns}$ ,  $t_P = 300 \text{ ps}$ , averaging window:  $t_P = 30 \text{ ns}$  to  $t_P = 30 \text{ ns}$  to  $t_P = 30 \text{ ns}$  to  $t_P = 30 \text{ ns}$ . extraction of dynamic resistance using least squares fit of TLP characteristics between ITLP1 = 16 A and ITLP2 = 30 A.

<sup>\*3:</sup> ITLP = 16 A

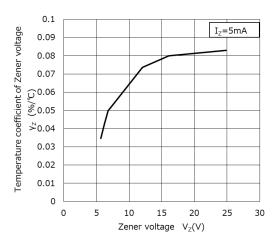
<sup>\*4:</sup> VR = 0 V, f = 1 MHz



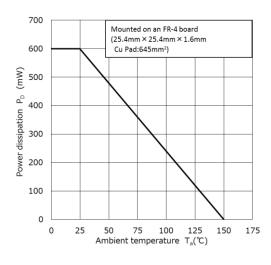
## **MUZ series Characteristics Curves (Note)**



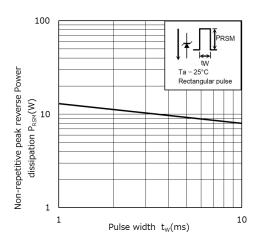




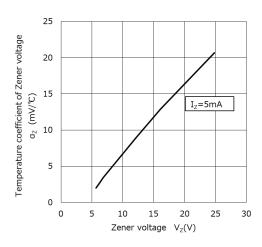
yz - Vz



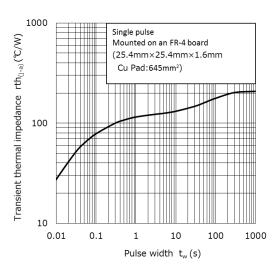
P<sub>D</sub> - T<sub>a</sub>



PRSM - tw



αz - Vz

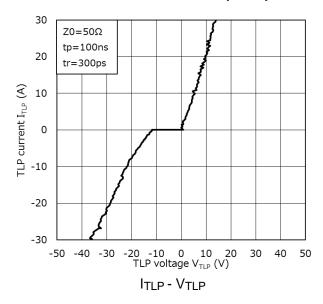


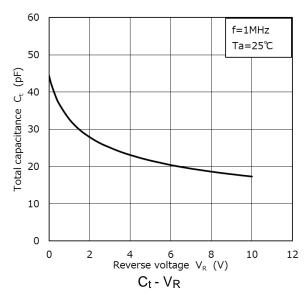
rth(j-a) - tw

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

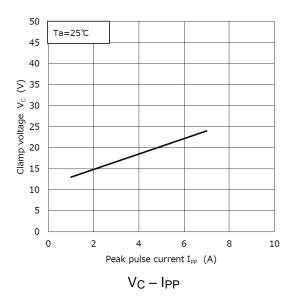


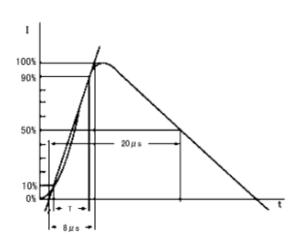
## **MUZ12V Characteristics Curves (Note)**





### MUZ12V Clamp Voltage - Peak Pulse Current (V<sub>C</sub> - I<sub>PP</sub>) (Note)



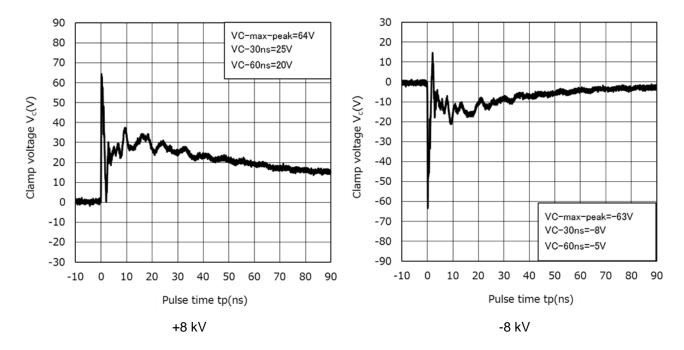


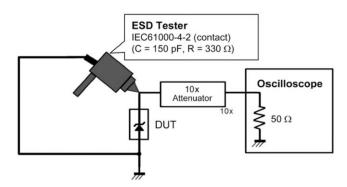
Based on IEC61000-4-5 8/20 µs pulse

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## **MUZ12V Clamp Waveform (Note)**





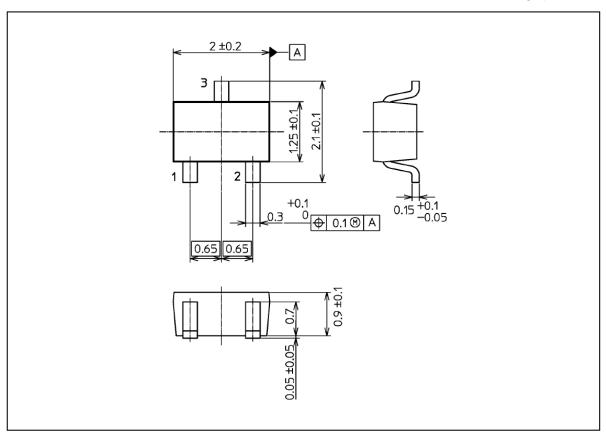
IEC61000-4-2 (Contact)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



# **Package Dimensions**

Unit: mm



Weight: 6.0 mg (typ.)



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